

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE01P30D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

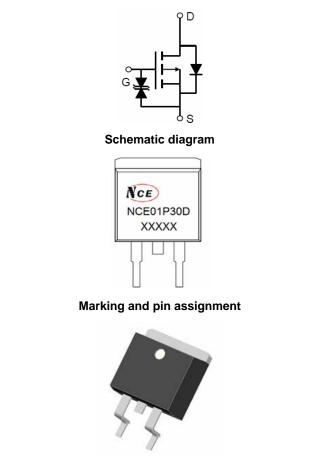
- V_{DS} =-100V,I_D =-30A
 R_{DS(ON)} <58mΩ @ V_{GS}=-10V (Typ:44mΩ)
 R_{DS(ON)} <65mΩ @ V_{GS}=-4.5V (Typ:48mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

Application

• Portable equipment and battery powered systems

100% UIS TESTED!

100% ΔVds TESTED!



TO-263-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P30D	NCE01P30D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

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Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	-100	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	Ι _D	-30	А	
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	-21	А	
Pulsed Drain Current	I _{DM}	-120	A	
Maximum Power Dissipation	PD	120	W	
Single pulse avalanche energy (Note 5)	E _{AS}	420	mJ	
Derating factor		0.8	W/℃	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C	
Thermal Characteristic				
Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	1.25	°C/W	



Electrical Characteristics (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics			•				
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-100	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±10	μA	
On Characteristics (Note 3)	·	·					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.5	-1.9	-2.5	V	
	R _{DS(ON)}	V _{GS} =-10V, I _D =-15A	-	44	58	mΩ	
Drain-Source On-State Resistance		V _{GS} =-4.5V, I _D =-15A	-	48	65		
Forward Transconductance	g fs	V _{DS} =-50V,I _D =-10A	5	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}	$\lambda = E_0 \lambda (\lambda = 0) \lambda$	-	8049	-	PF	
Output Capacitance	Coss	V _{DS} =-50V,V _{GS} =0V, F=1.0MHz	-	184.5	-	PF	
Reverse Transfer Capacitance	C _{rss}		-	179	-	PF	
Switching Characteristics (Note 4)	·	·					
Turn-on Delay Time	t _{d(on)}		-	17	-	nS	
Turn-on Rise Time	tr	V _{DD} =-50V,I _D =-15A	-	80	-	nS	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _{GEN} =9.1Ω	-	45	-	nS	
Turn-Off Fall Time	t _f		-	65	-	nS	
Total Gate Charge	Qg		-	120	-	nC	
Gate-Source Charge	Q _{gs}	V _{DS} =-50V,I _D =-15A, V _{GS} =-10V	-	22	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	26.4	-	nC	
Drain-Source Diode Characteristics	·	·					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-10A	-	-	-1.2	V	
Diode Forward Current (Note 2)	I _S	-	-	-	-30	А	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-15A	-	90	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	150	-	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			y LS+LD)		

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

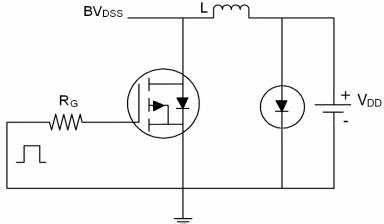
3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

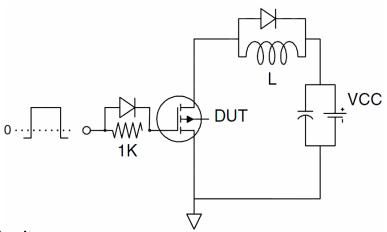
5. EAS condition: Tj=25 $^\circ C$,V_DD=-50V,V_G=-10V,L=0.5mH,Rg=25\Omega



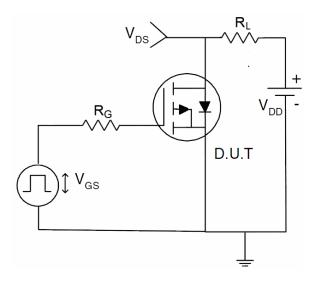
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

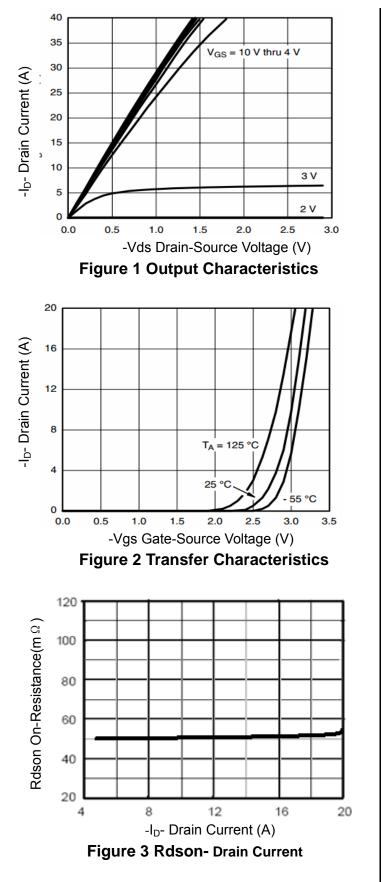


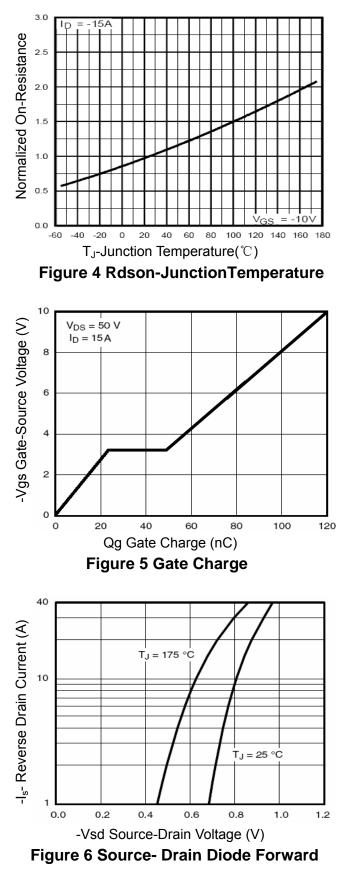
3) Switch Time Test Circuit





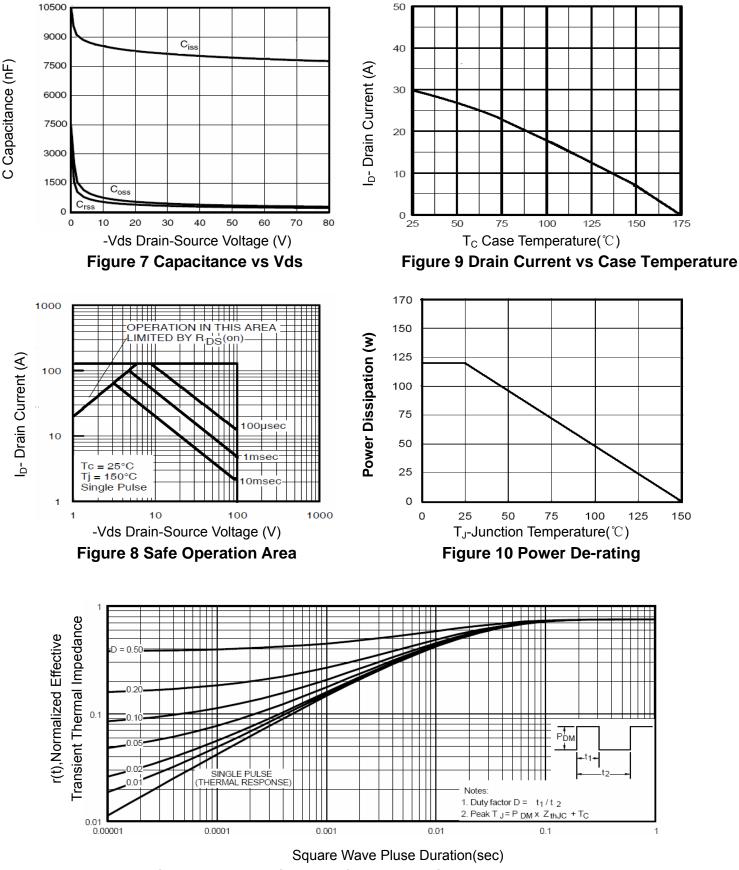
Typical Electrical and Thermal Characteristics (Curves)







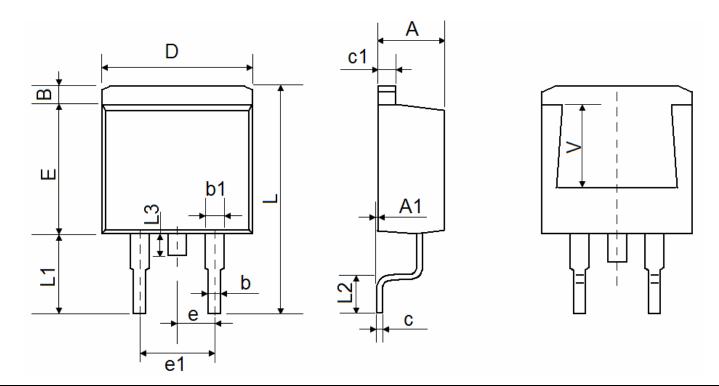
http://www.ncepower.com







TO-263-2L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600	0 REF	0.220 REF		



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